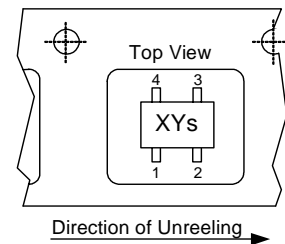
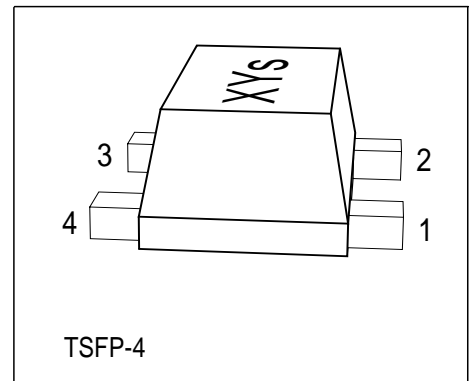


**NPN Silicon Germanium RF Transistor\***

- High gain ultra low noise RF transistor
- Provides outstanding performance for a wide range of wireless applications up to 10 GHz
- Ideal for CDMA and WLAN applications
- Outstanding noise figure  $F = 0.5$  dB at 1.8 GHz  
Outstanding noise figure  $F = 0.75$  dB at 6 GHz
- High maximum stable gain  
 $G_{ms} = 27.5$  dB at 1.8 GHz
- Gold metallization for extra high reliability
- 150 GHz  $f_T$ -Silicon Germanium technology

\* Short-term description



**ESD: Electrostatic discharge sensitive device, observe handling precaution!**

Type	Marking	Pin Configuration						Package
BFP740F	R7s	1=B	2=E	3=C	4=E	-	-	TSFP-4

**Maximum Ratings**

Parameter	Symbol	Value	Unit
Collector-emitter voltage	$V_{CEO}$	4	V
$T_A > 0^\circ\text{C}$		4	
$T_A \leq 0^\circ\text{C}$		3.5	
Collector-emitter voltage	$V_{CES}$	13	
Collector-base voltage	$V_{CBO}$	13	
Emitter-base voltage	$V_{EBO}$	1.2	
Collector current	$I_C$	30	mA
Base current	$I_B$	3	
Total power dissipation <sup>1)</sup>	$P_{tot}$	160	mW
$T_S \leq 90^\circ\text{C}$			
Junction temperature	$T_j$	150	$^\circ\text{C}$
Ambient temperature	$T_A$	-65 ... 150	
Storage temperature	$T_{stg}$	-65 ... 150	

<sup>1</sup>  $T_S$  is measured on the collector lead at the soldering point to the pcb

**Thermal Resistance**

Parameter	Symbol	Value	Unit
Junction - soldering point <sup>1)</sup>	$R_{thJS}$	$\leq 370$	K/W

**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

**DC Characteristics**

Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(BR)CEO}$	4	4.7	-	V
Collector-emitter cutoff current $V_{CE} = 13 \text{ V}, V_{BE} = 0$	$I_{CES}$	-	-	30	$\mu\text{A}$
Collector-base cutoff current $V_{CB} = 5 \text{ V}, I_E = 0$	$I_{CBO}$	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 0.5 \text{ V}, I_C = 0$	$I_{EBO}$	-	-	3	$\mu\text{A}$
DC current gain $I_C = 25 \text{ mA}, V_{CE} = 3 \text{ V}$	$h_{FE}$	160	250	400	-

<sup>1)</sup>For calculation of  $R_{thJA}$  please refer to Application Note Thermal Resistance

**Electrical Characteristics at  $T_A = 25^\circ\text{C}$ , unless otherwise specified**

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
<b>AC Characteristics (verified by random sampling)</b>					
Transition frequency $I_C = 25 \text{ mA}, V_{CE} = 3 \text{ V}, f = 1 \text{ GHz}$	$f_T$	-	42	-	GHz
Collector-base capacitance $V_{CB} = 3 \text{ V}, f = 1 \text{ MHz}$	$C_{cb}$	-	0.08	-	pF
Collector emitter capacitance $V_{CE} = 3 \text{ V}, f = 1 \text{ MHz}$	$C_{ce}$	-	0.25	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	$C_{eb}$	-	0.45	-	
Noise figure $I_C = 8 \text{ mA}, V_{CE} = 3 \text{ V}, f = 1.8 \text{ GHz}, Z_S = Z_{Sopt}$ $I_C = 8 \text{ mA}, V_{CE} = 3 \text{ V}, f = 6 \text{ GHz}, Z_S = Z_{Sopt}$	$F$	-	0.5 0.75	-	dB
Power gain, maximum stable <sup>1)</sup> $I_C = 25 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{Sopt},$ $Z_L = Z_{Lopt}, f = 1.8 \text{ GHz}$	$G_{ms}$	-	27.5	-	dB
Power gain, maximum available <sup>1)</sup> $I_C = 25 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_{Sopt},$ $Z_L = Z_{Lopt}, f = 6 \text{ GHz}$	$G_{ma}$	-	19	-	dB
Transducer gain $I_C = 25 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50 \Omega,$ $f = 1.8 \text{ GHz}$ $I_C = 25 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50 \Omega,$ $f = 6 \text{ GHz}$	$ S_{21e} ^2$	-	25 14.5	-	dB
Third order intercept point at output <sup>2)</sup> $V_{CE} = 3 \text{ V}, I_C = 25 \text{ mA}, f = 1.8 \text{ GHz},$ $Z_S = Z_L = 50 \Omega$	$IP_3$	-	26	-	dBm
1dB Compression point at output $I_C = 25 \text{ mA}, V_{CE} = 3 \text{ V}, Z_S = Z_L = 50 \Omega,$ $f = 1.8 \text{ GHz}$	$P_{-1dB}$	-	12	-	

<sup>1</sup> $G_{ma} = |S_{21e} / S_{12e}| (k - (k^2 - 1)^{1/2}), G_{ms} = |S_{21e} / S_{12e}|$ 
<sup>2</sup> $IP_3$  value depends on termination of all intermodulation frequency components.  
Termination used for this measurement is  $50\Omega$  from 0.1 MHz to 6 GHz

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